

## 1、Description

Passivated triacs in a full pack plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting heating and static switching.

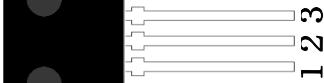
## 2、Applications

- Motor control
- Industrial and domestic lighting
- Heating
- Static switching

## 3、Features

- Blocking voltage to 600 thru 800 V
- On-state RMS current to 4 A
- Ultra low gate trigger current
- Low cost package.

## 4、Pinning information

PIN	Description	Simplified outline	Symbol
1	main terminal 1(T1)	 SOT-82	
2	main terminal 2(T2)		
3	gate (G)		

## 5、Quick reference data

SYMBOL	PARAMETER	MAX	UNIT
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltages	600	V
$I_{T(RMS)}$	RMS on-state current	4	A
$I_{tSM}$	Non-repetitive peak on-state current	25	A

## 6、Thermal characteristics

SYMBOL	PARAMETER	Value	UNIT
$R_{th(j-c)}$	junction to case(AC)	4.1	°C/W

## 7、Limiting value

Limiting values in accordance with the Maximum System(IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
$V_{DRM}$	Repetitive peak off-state voltages		-	600	V
$I_{TRMS}$	RMS on-state current	Full Cycle Sine Wave 50 to 60 Hz ( $T_C = 107^\circ C$ )	-	4	A
$I_{TSM}$	Non-repetitive peak Surge current	One Full cycle, 60 Hz, $T_J = +110^\circ C$	-	25	A
$I^2t$	$I^2t$ for fusing	$t = 8.3ms$	-	3.1	$A^2s$
$V_{GM}$	Peak gate voltage	Pulse Width $\leq 1.0 \mu s$ , $T_C = 85^\circ C$	-	5	V
$P_{GM}$	Peak gate power	Pulse Width $\leq 1.0 \mu s$ , $T_C = 85^\circ C$	-	5	W
$P_{G(AV)}$	Average gate power	Pulse Width $\leq 1.0 \mu s$ , $T_C = 85^\circ C$	-	0.5	W
$T_{stg}$	Storage temperature		-40	150	$^\circ C$
$T_j$	Operating junction temperature		-40	125	$^\circ C$

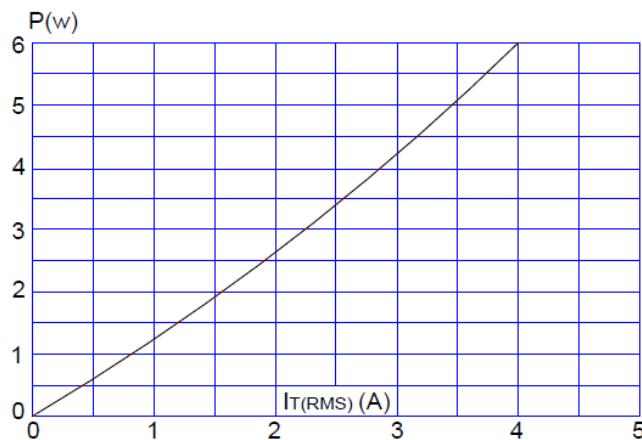
## 8、Characteristics

$T_J = 25^\circ C$  unless otherwise stated

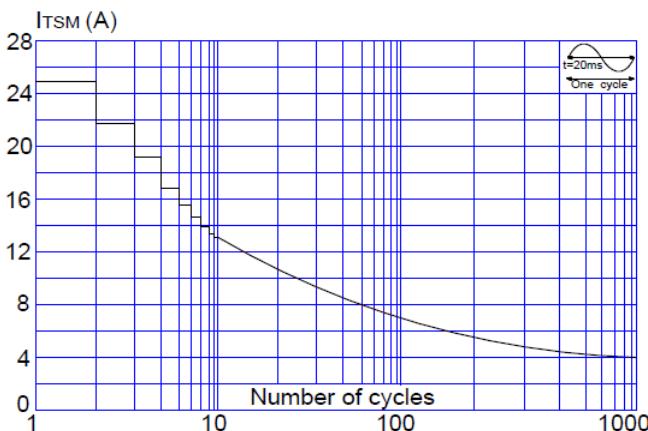
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
<b>Static characteristics</b>						
$I_{GT}$	Gate trigger current	$V_D = 12 V$ ; $I_T = 0.1A$ T2+ G+ T2+ G- T2- G- T2- G+	-	-	5	mA
$I_L$	Latching current	$V_D = 12 V$ ; $I_{GT} = 0.1A$ T2+ G+ T2+ G- T2- G- T2- G+	-	-	20	mA
$I_H$	Holding current	Main Terminal Voltage = 12 Vdc, Gate Open, Initiating Current $\leq 1 A$ dc $T_J = 25^\circ C$	-	-	25	mA
$V_{TM}$	On-state voltage	$I_{TM} = 5.5A$ , $t_p=380\mu s$	-	-	1.7	V
$V_{GT}$	Gate trigger voltage (Continuous dc)	Main Terminal Voltage = 12 Vdc, $R_L$ = 100 Ohms, $T_J = -40^\circ C$ All Quadrants	-	-	1.5	V
$V_{GD}$	Gate Non-Trigger Voltage	$V_D=V_{DRM}$ $T_J=125^\circ C$ $R_L=3.3K\Omega$	0.2	-	-	V
<b>Dynamic Characteristics</b>						
$dV/dt$	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}$ ; $T_J = 125^\circ C$ ; Exponential wave form; $RGK=1K\Omega$	5	-	-	$V/\mu s$
$(dV/dt)c$	Critical rate of change of commutating voltage	$(dI/dt)c=-1.7A/ms$ $T_J=125^\circ C$	0.1	-	-	$V/\mu s$

## 9. Electrical Characteristics Curve

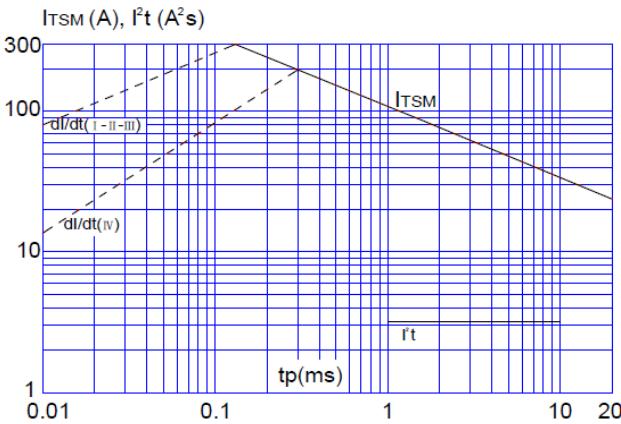
**FIG.1** Maximum power dissipation versus RMS on-state current



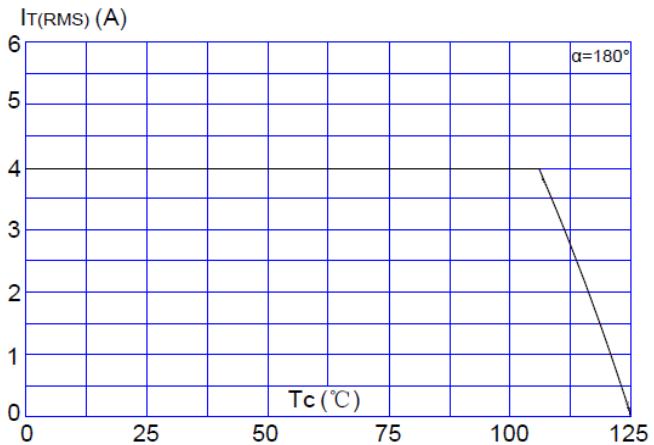
**FIG.3:** Surge peak on-state current versus number of cycles



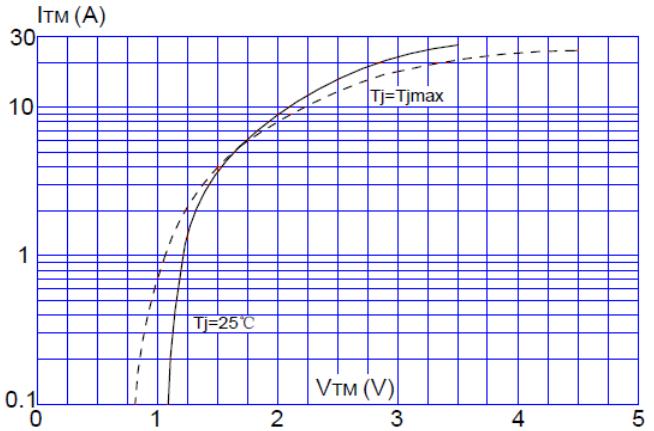
**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 20\text{ms}$  and corresponding value of  $I^2t$  (I - II - III:  $di/dt < 50\text{A}/\mu\text{s}$ ; IV:  $di/dt < 10\text{A}/\mu\text{s}$ )



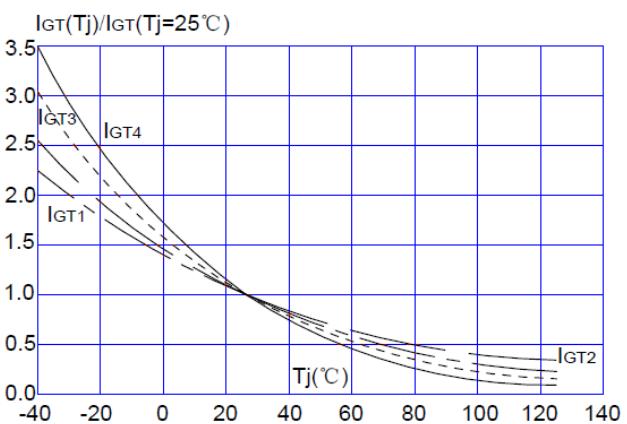
**FIG.2:** RMS on-state current versus case temperature



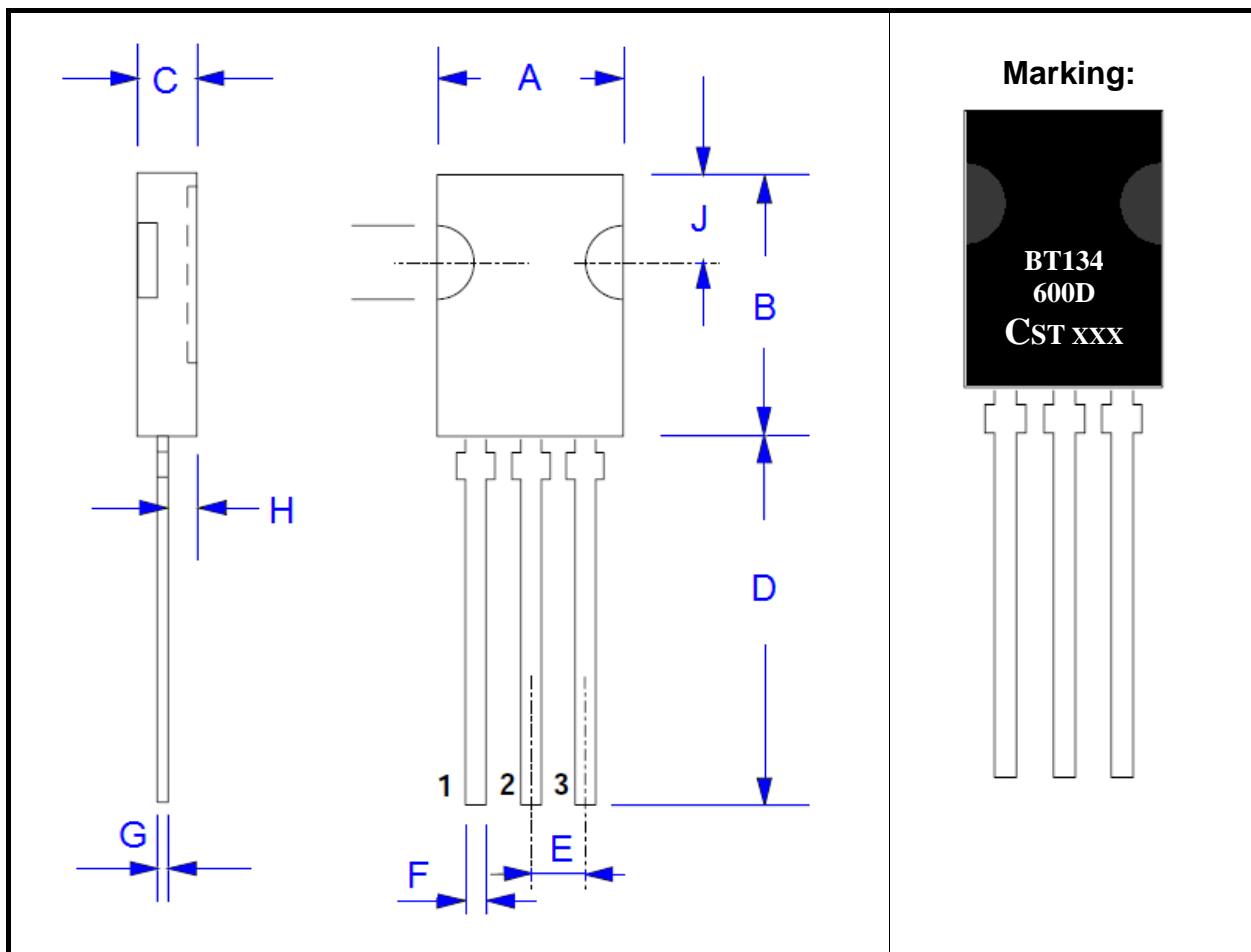
**FIG.4:** On-state characteristics (maximum values)



**FIG.6:** Relative variations of gate trigger current versus junction temperature



## 10、Package outline(SOT-82)



DIM	Inches			Millimeters		
	Min	Type	Max	Min	Type	Max
A	-	-	0.305	-	-	7.75
B	-	-	0.445	-	-	11.3
C	0.091	-	0.110	2.3	-	2.8
D	0.571	-	-	14.5	-	-
E	-	0.090	-	-	2.29	-
F	-	-	0.035	-	-	0.88
G	-	0.019	-	-	0.48	-
H	-	0.049	-	-	1.25	-
J	-	0.148	-	-	3.75	-

CST